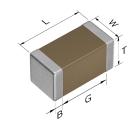
积层贴片陶瓷片式电容器

C1608X5R1C475K080AC

RoHS Reach Halogen Free Pb Free

交货型号	C1608X5R1C475KT****
用途	一般等级
特点	General 一般(~75V)
系列	C1608 [EIA 0603]
状态	量产体制



尺寸		
长度(L)	1.60mm ± 0.10 mm	
宽度(W)	0.80 mm ± 0.10 mm	
厚度(T)	0.80 mm ± 0.10 mm	
端子宽度(B)	0.20mm Min.	
端子间隔(G)	0.30mm Min.	
推荐焊盘布局(PA)	0.70mm to 1.00mm(Flow Soldering)	
]世代/年益/印/印 (L fl/)	0.60mm to 0.80mm(Reflow Soldering)	
推荐焊盘布局(PB)	0.80mm to 1.00mm(Flow Soldering)	
]世代/年益/旧/四 (LD)	0.60mm to 0.80mm(Reflow Soldering)	
推荐焊盘布局(PC)	0.60mm to 0.80mm(Flow Soldering)	
3世代が中無44月以107	0.60mm to 0.80mm(Reflow Soldering)	

······································	气特性
电容	$4.7\mu\mathrm{F}\pm10\%$
额定电压	16VDC
温度特性	$X5R(\pm 15\%)$
耗散因数(Max.)	10%
绝缘电阻 (Min.)	21ΜΩ

	其他	
M1 + 1/2 2-1-1	流体	
焊接方法	回流	
AEC-Q200	NO NO	
包装形式	纸编带 (180mm卷筒)	
包装个数	4000pcs	

[!] Images are for reference only and show exemplary products.

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[!] All specifications are subject to change without notice.



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特性图表(这是参考数据,并不保证产品的特性。)

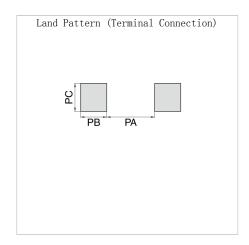
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Associated Images



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